

Chip NTC Thermistors (Sensor)

Product Top Page	Search by Part No.	Search by Characteristics	Cross Reference	Catalog	Tech Notes	Technical Support Tools	FAQ
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B57999V5999J199

Applications	Automotive Grade
Features	150°C 150°C UL UL Certificate AEC-Q200 AEC-Q200
Type	Kit
Status	Production
Brand	EPCOS



Images are for reference only and show exemplary products.

Size	
L x W Size	
Thickness Height	
Detail Size Information	Please refer to the data sheet

Electrical Characteristics	
Resistance [at 25°C]	
Resistance Tolerance	
B value [25/50°C]	
B value [25/85°C]	
B value [25/100°C]	
B value Tolerance	
Max. Electric Power [at 25°C]	
Permissible Operating Current [at 25°C]	
Thermal Dissipation Constant [at 25°C]	
Further Details	Please refer to the data sheet

Other	
Max. Operating Temperature	150°C
UL File No.	E69802
AEC-Q200	Yes
Soldering Method	Please refer to the document (Mounting Instructions)
Packing	Please refer to the document (Taping and Packing)

?

RoHS

REACH SVHC-Free

Halogen Free

Lead Free

PDF file of this page

Contact

Documents
Data Sheet
General Technical Information
Cautions and Warnings
Quality and Environment
Symbols and Terms
Taping and Packing
Mounting Instructions
Climatic Conditions
RoHS and SVHC/REACH Declaration
Material Data Sheets
Application Note
[Application Note] How to Use Temperature Protection Devices : Chip NTC Thermistors
R/T characteristics

Technical Support Tools
Sample Kits
NTC R/T Calculation
NTC Thermistor Library for PSpice



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Voltage / Current / Temperature Protection Devices	>
Sensors and Sensor Systems	>
Ceramic Switching / Heating, Piezo Components, Buzzers and Microphones	>
Transformers	>
Ferrites and Accessories	>
Noise Suppressing / Magnetic Sheet	>
Anechoic Chambers and Radio Wave Absorbers	>
Power Supplies	>
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